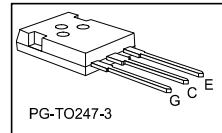
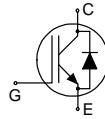


## Reverse conducting IGBT

### Features:

- Powerful monolithic body diode with low forward voltage designed for soft commutation only
- TrenchStop® technology applications offers:
  - very tight parameter distribution
  - high ruggedness, temperature stable behavior
  - low  $V_{CEsat}$
  - easy parallel switching capability due to positive temperature coefficient in  $V_{CEsat}$
- Low EMI
- Qualified according to JEDEC J-STD-020 and JESD-022 for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models:  
<http://www.infineon.com/igbt/>



### Applications:

- Inductive cooking

Type	$V_{CE}$	$I_C$	$V_{CEsat}, T_{vj}=25^\circ\text{C}$	$T_{vjmax}$	Marking	Package
IHW40N60R	600V	40A	1.65V	175°C	H40R60	PG-T0247-3

### Maximum ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CE}$	600	V
DC collector current, limited by $T_{vjmax}$ $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	$I_C$	80.0 40.0	A
Pulsed collector current, $t_p$ limited by $T_{vjmax}$	$I_{Cpuls}$	120.0	A
Turn off safe operating area $V_{CE} = 600\text{V}$ , $T_{vj} = 175^\circ\text{C}$	-	120.0	A
Diode forward current, limited by $T_{vjmax}$ $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	$I_F$	80.0 40.0	A
Diode pulsed current, $t_p$ limited by $T_{vjmax}$	$I_{Fpuls}$	120.0	A
Gate-emitter voltage	$V_{GE}$	$\pm 20$	V
Power dissipation $T_C = 25^\circ\text{C}$ Power dissipation $T_C = 100^\circ\text{C}$	$P_{tot}$	305.0 152.5	W
Operating junction temperature	$T_{vj}$	-40...+175	°C
Storage temperature	$T_{stg}$	-55...+175	°C
Soldering temperature, wavesoldering 1.6 mm (0.063 in.) from case for 10s		260	°C
Mounting torque, M3 screw Maximum of mounting processes: 3	$M$	0.6	Nm

**Thermal Resistance**

Parameter	Symbol	Conditions	Max. Value	Unit
<b>Characteristic</b>				
IGBT thermal resistance, junction - case	$R_{th(j-c)}$		0.49	K/W
Diode thermal resistance, junction - case	$R_{th(j-c)}$		0.49	K/W
Thermal resistance junction - ambient	$R_{th(j-a)}$		40	K/W

**Electrical Characteristic, at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>Static Characteristic</b>						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE} = 0\text{V}, I_c = 0.50\text{mA}$	600	-	-	V
Collector-emitter saturation voltage	$V_{CEsat}$	$V_{GE} = 15.0\text{V}, I_c = 40.0\text{A}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$	-	1.65	2.05	V
Diode forward voltage	$V_F$	$V_{GE} = 0\text{V}, I_F = 40.0\text{A}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$	-	1.65	2.05	V
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_c = 0.58\text{mA}, V_{CE} = V_{GE}$	4.1	4.9	5.7	V
Zero gate voltage collector current	$I_{CES}$	$V_{CE} = 600\text{V}, V_{GE} = 0\text{V}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$	-	-	40.0 1000.0	$\mu\text{A}$
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}$	-	-	100	nA
Transconductance	$g_{fs}$	$V_{CE} = 20\text{V}, I_c = 40.0\text{A}$	-	19.0	-	S
Integrated gate resistor	$r_G$			none		$\Omega$

**Electrical Characteristic, at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified**

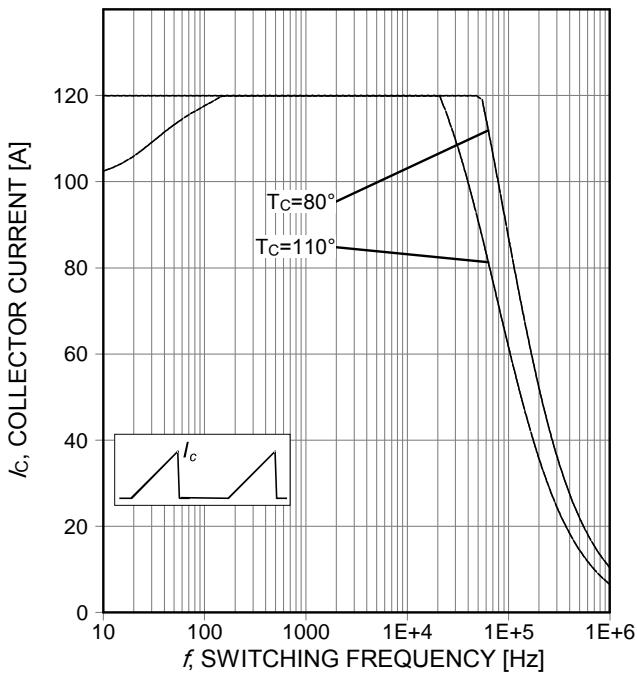
Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>Dynamic Characteristic</b>						
Input capacitance	$C_{ies}$		-	2370	-	
Output capacitance	$C_{oes}$	$V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$	-	81	-	pF
Reverse transfer capacitance	$C_{res}$		-	63	-	
Gate charge	$Q_G$	$V_{CC} = 480\text{V}, I_c = 40.0\text{A}, V_{GE} = 15\text{V}$	-	223.0	-	
Internal emitter inductance measured 5mm (0.197 in.) from case	$L_E$		-	13.0	-	nH

**Switching Characteristic, Inductive Load, at  $T_{vj} = 25^\circ\text{C}$** 

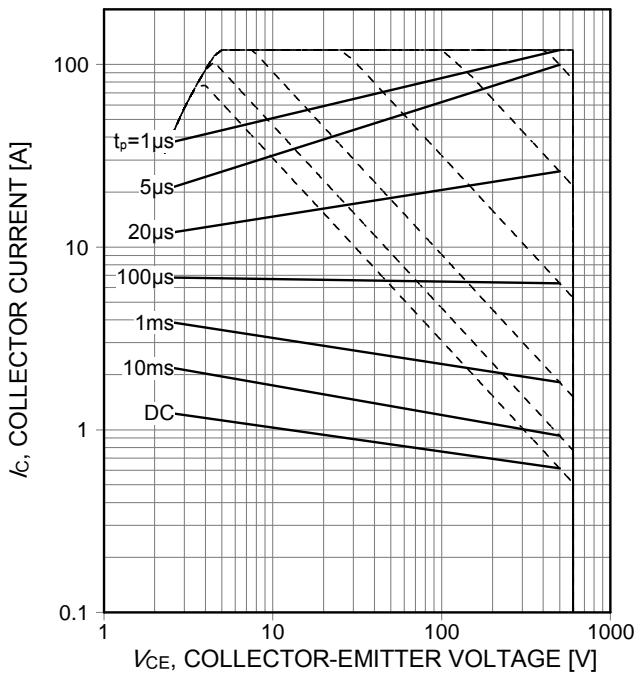
Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>IGBT Characteristic</b>						
Turn-off delay time	$t_{d(\text{off})}$	$T_{vj} = 25^\circ\text{C}$ , $V_{CC} = 400\text{V}$ , $I_C = 40.0\text{A}$ , $V_{GE} = 0.0/15.0\text{V}$ ,	-	193	-	ns
Fall time	$t_f$	$r_G = 5.6\Omega$ , $L_\sigma = 90\text{nH}$ , $C_\sigma = 67\text{pF}$	-	24	-	ns
Turn-off energy	$E_{\text{off}}$	$L_\sigma$ , $C_\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	0.75	-	mJ

**Switching Characteristic, Inductive Load, at  $T_{vj} = 175^\circ\text{C}$** 

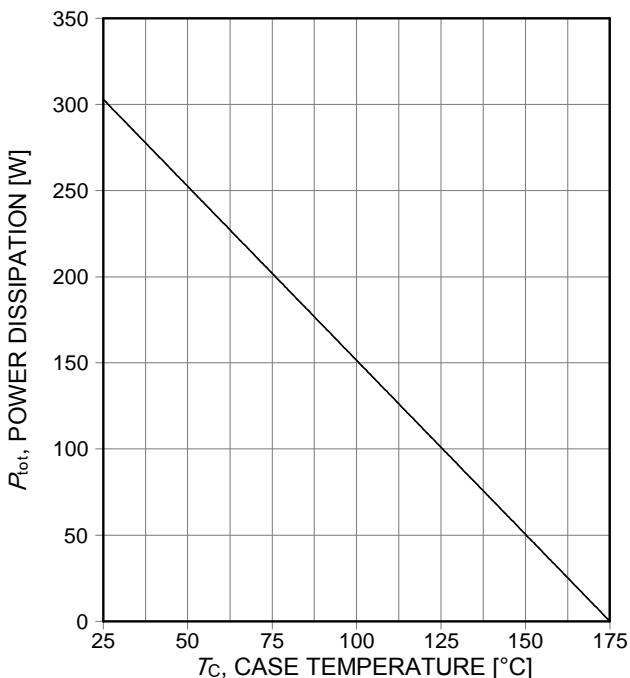
Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>IGBT Characteristic</b>						
Turn-off delay time	$t_{d(\text{off})}$	$T_{vj} = 175^\circ\text{C}$ , $V_{CC} = 400\text{V}$ , $I_C = 40.0\text{A}$ , $V_{GE} = 0.0/15.0\text{V}$ ,	-	227	-	ns
Fall time	$t_f$	$r_G = 5.6\Omega$ , $L_\sigma = 90\text{nH}$ , $C_\sigma = 67\text{pF}$	-	37	-	ns
Turn-off energy	$E_{\text{off}}$	$L_\sigma$ , $C_\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	1.22	-	mJ



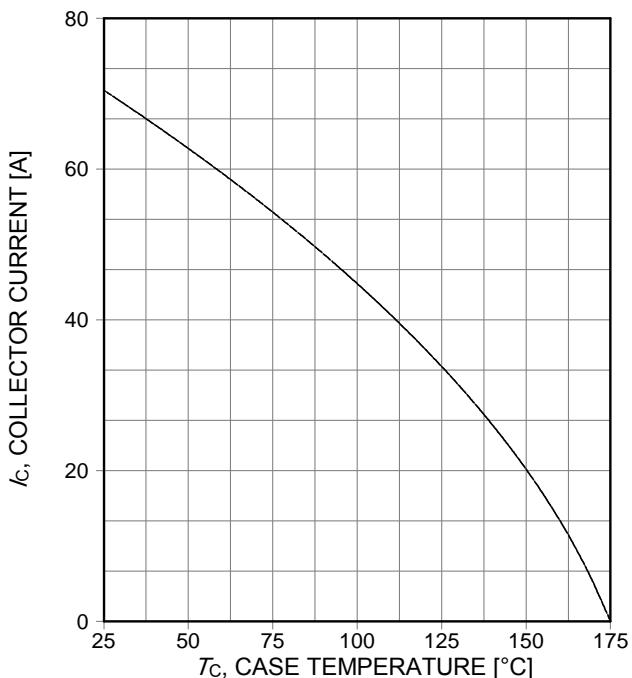
**Figure 1. Collector current as a function of switching frequency**  
 $(T_j \leq 175^\circ\text{C}, D=0.5, V_{CE}=400\text{V}, V_{GE}=15/0\text{V}, R_G=5.6\Omega)$



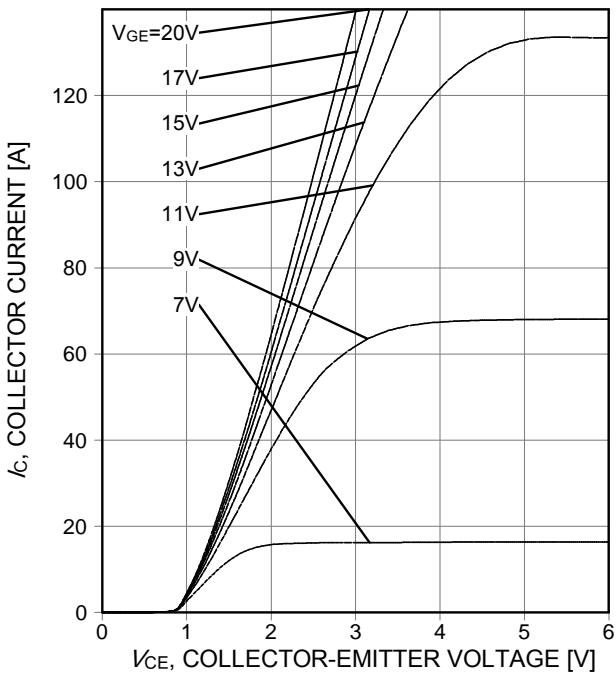
**Figure 2. Forward bias safe operating area**  
 $(D=0, T_C=25^\circ\text{C}, T_j \leq 175^\circ\text{C}; V_{GE}=15\text{V})$



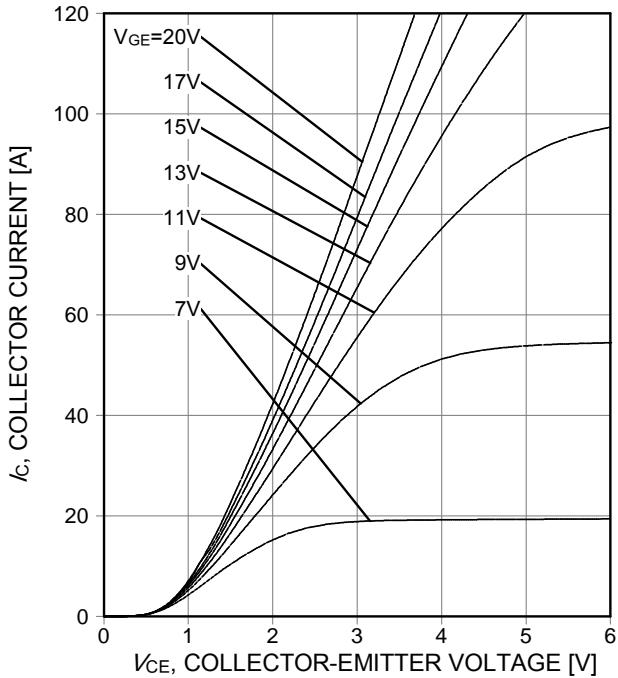
**Figure 3. Power dissipation as a function of case temperature**  
 $(T_j \leq 175^\circ\text{C})$



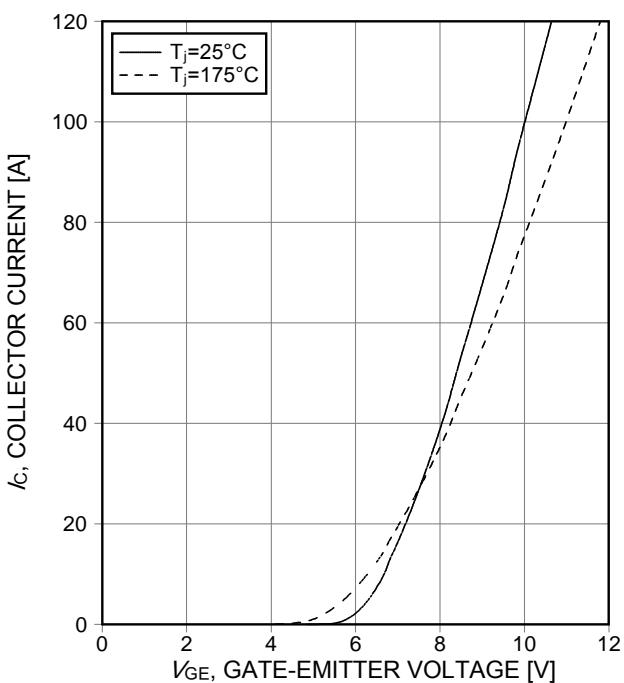
**Figure 4. Collector current as a function of case temperature**  
 $(V_{GE} \geq 15\text{V}, T_j \leq 175^\circ\text{C})$



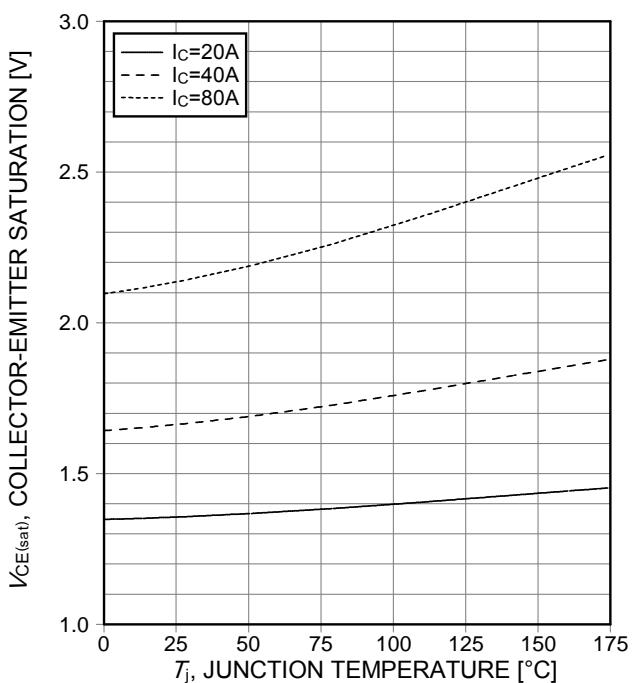
**Figure 5. Typical output characteristic**  
( $T_j=25^\circ\text{C}$ )



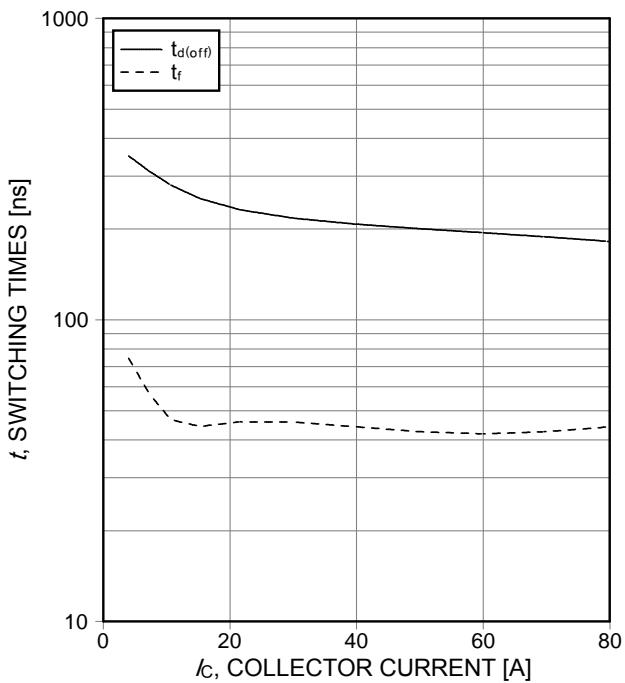
**Figure 6. Typical output characteristic**  
( $T_j=175^\circ\text{C}$ )



**Figure 7. Typical transfer characteristic**  
( $V_{CE}=20\text{V}$ )

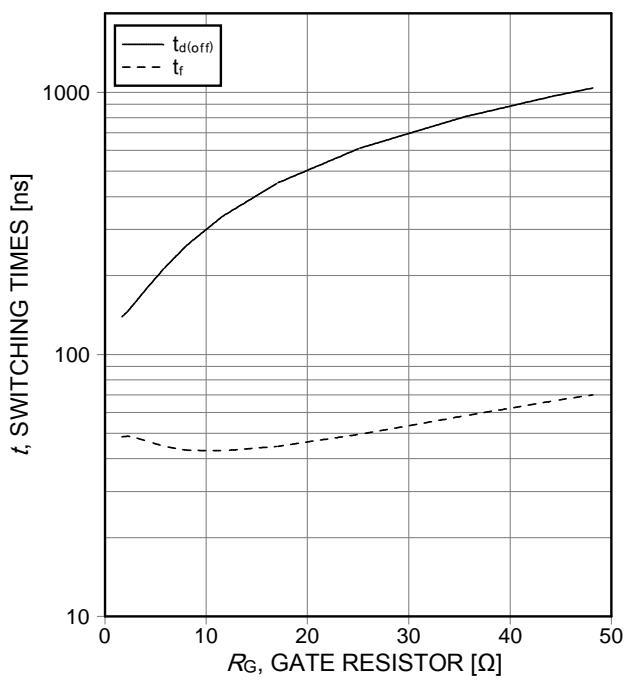


**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE}=15\text{V}$ )



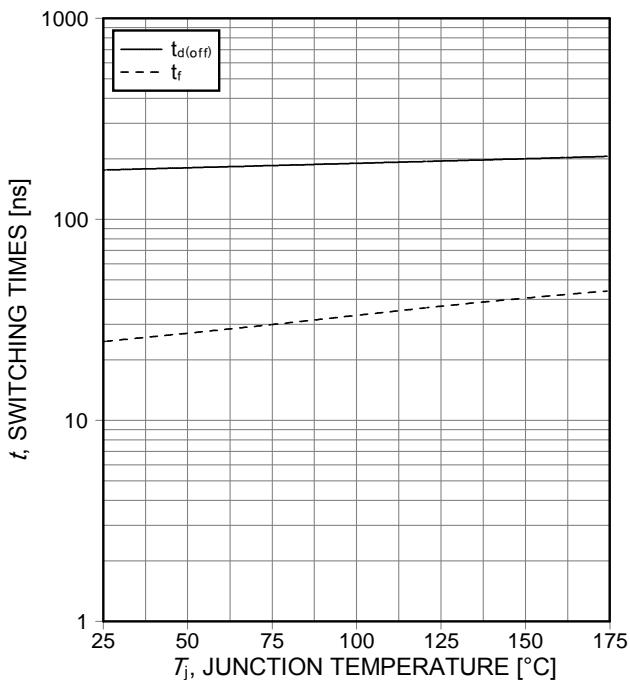
**Figure 9. Typical switching times as a function of collector current**

(inductive load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $R_G=5.6\Omega$ , Dynamic test circuit in Figure E)



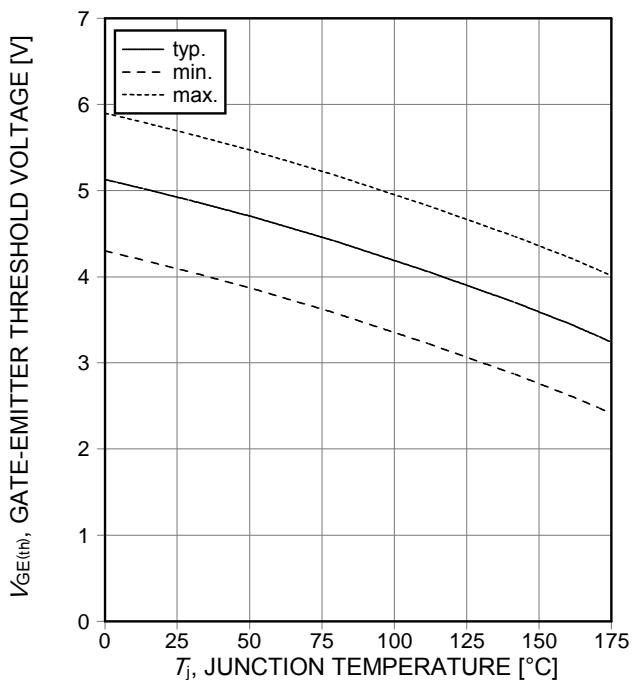
**Figure 10. Typical switching times as a function of gate resistor**

(inductive load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_c=40\text{A}$ , Dynamic test circuit in Figure E)



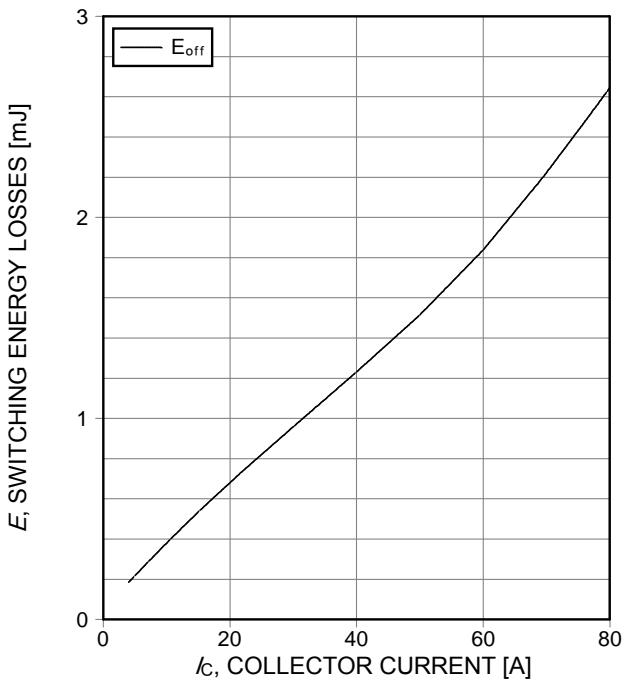
**Figure 11. Typical switching times as a function of junction temperature**

(inductive load,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_c=40\text{A}$ ,  $R_G=5.6\Omega$ , Dynamic test circuit in Figure E)

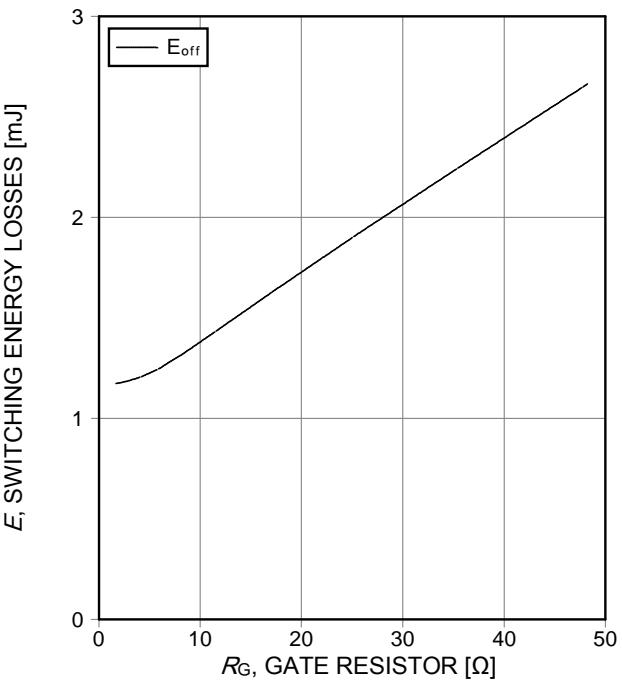


**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**

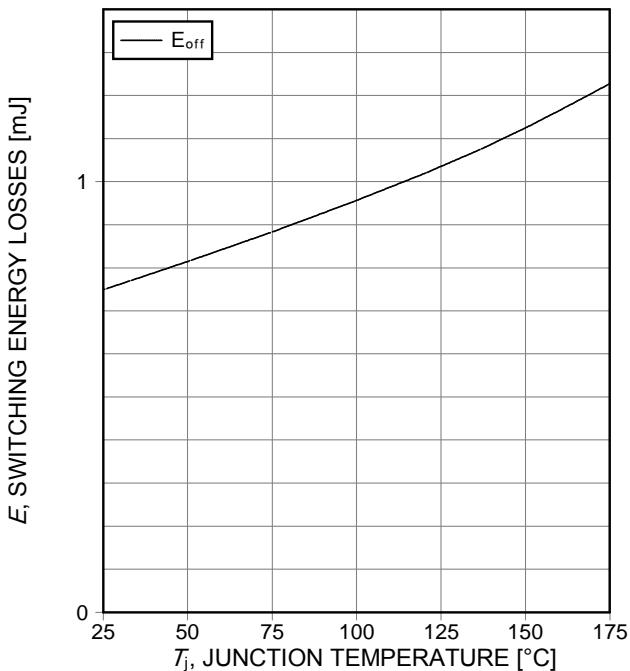
( $I_c=0.6\text{mA}$ )



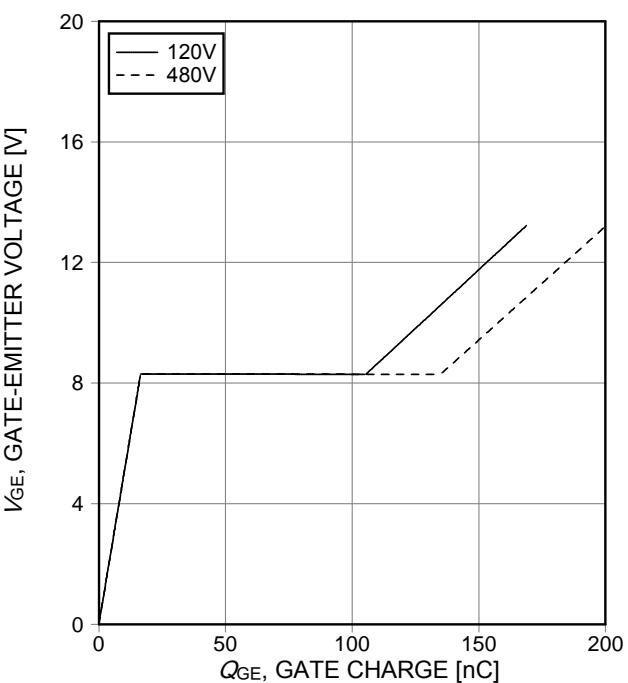
**Figure 13. Typical switching energy losses as a function of collector current**  
(inductive load,  $T_j=175^\circ\text{C}$ ,  $V_{\text{CE}}=400\text{V}$ ,  $V_{\text{GE}}=15/0\text{V}$ ,  $R_G=5.6\Omega$ , Dynamic test circuit in Figure E)



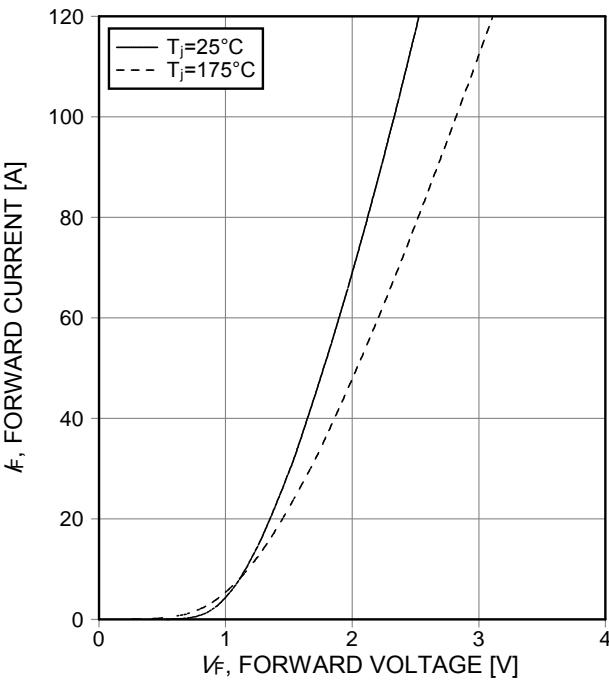
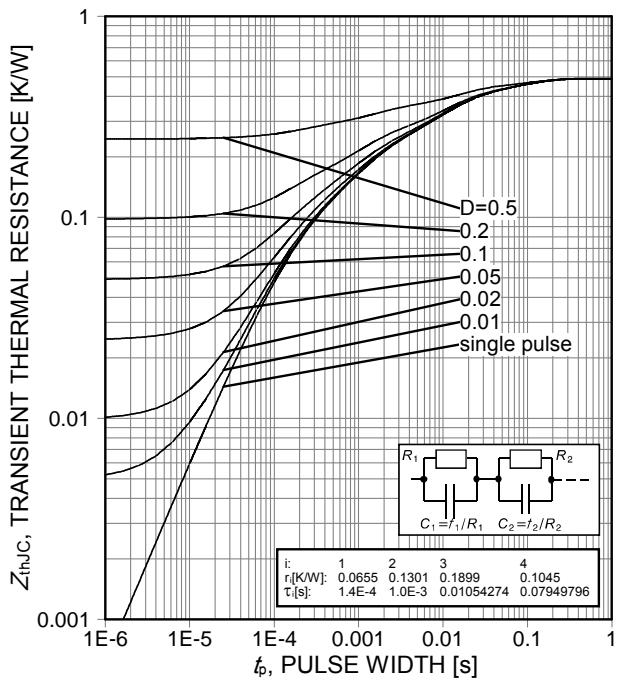
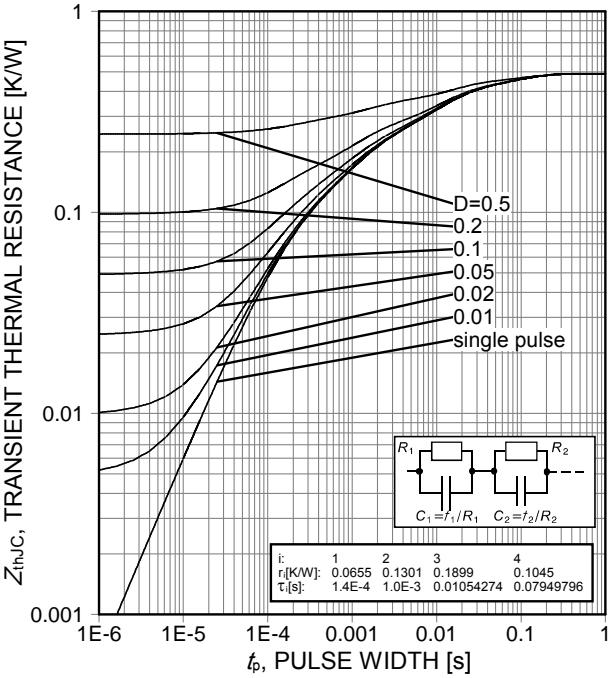
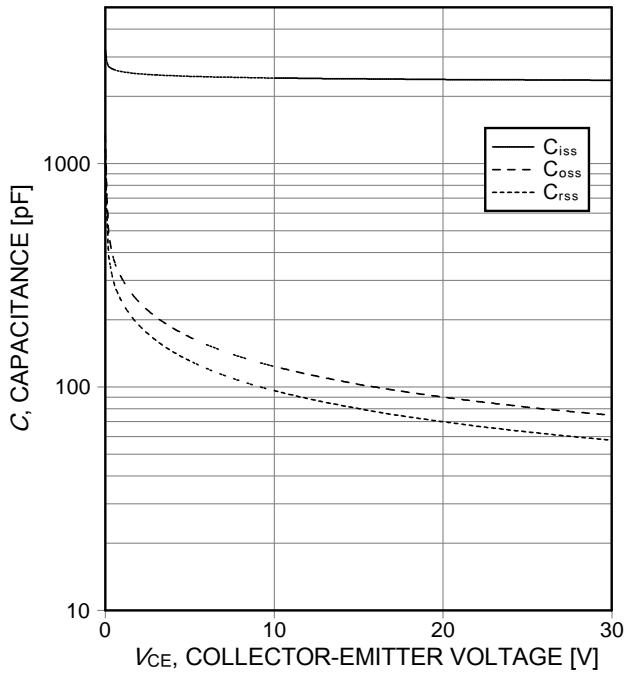
**Figure 14. Typical switching energy losses as a function of gate resistor**  
(inductive load,  $T_j=175^\circ\text{C}$ ,  $V_{\text{CE}}=400\text{V}$ ,  $I_C=40\text{A}$ ,  $V_{\text{GE}}=15/0\text{V}$ , Dynamic test circuit in Figure E)



**Figure 15. Typical switching energy losses as a function of junction temperature**  
(inductive load,  $V_{\text{CE}}=400\text{V}$ ,  $V_{\text{GE}}=15/0\text{V}$ ,  $I_C=40\text{A}$ ,  $R_G=5.6\Omega$ , Dynamic test circuit in Figure E)



**Figure 16. Typical gate charge**  
( $I_C=40\text{A}$ )



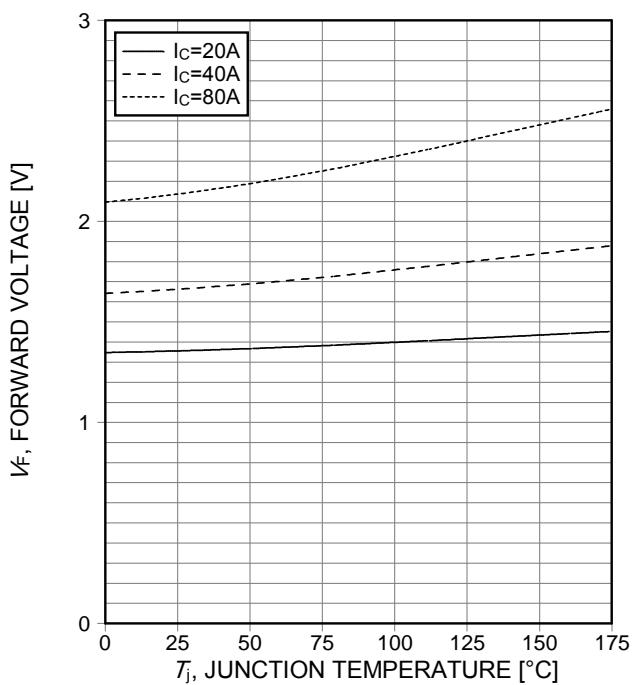
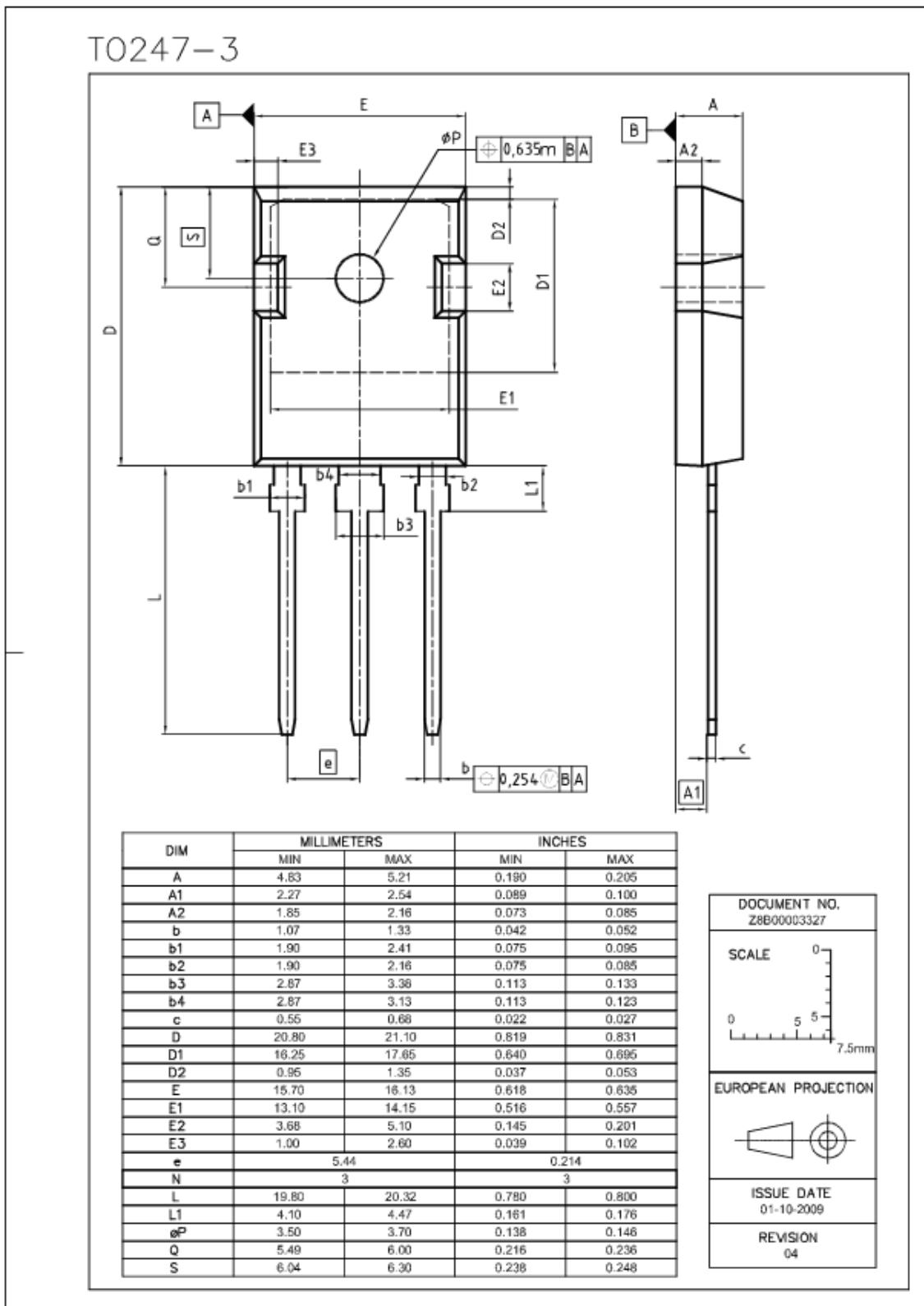
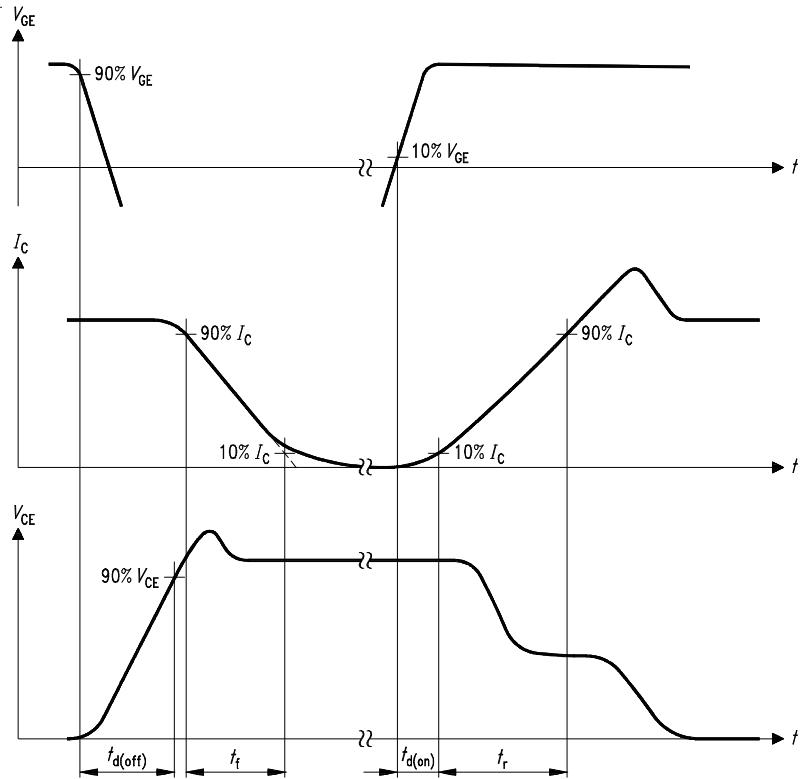


Figure 21. Typical diode forward voltage as a function of junction temperature

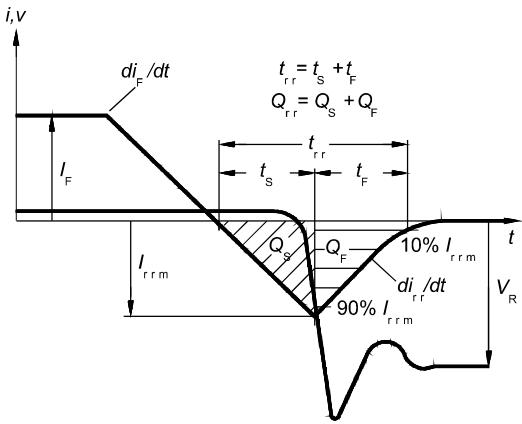
## PG-T0247-3



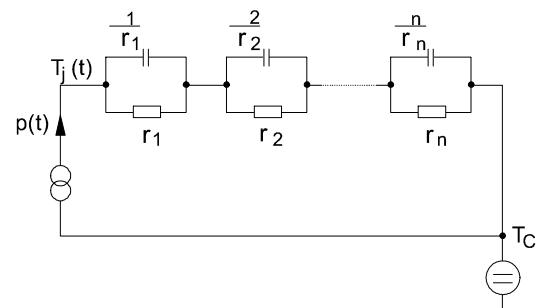
## IH-series



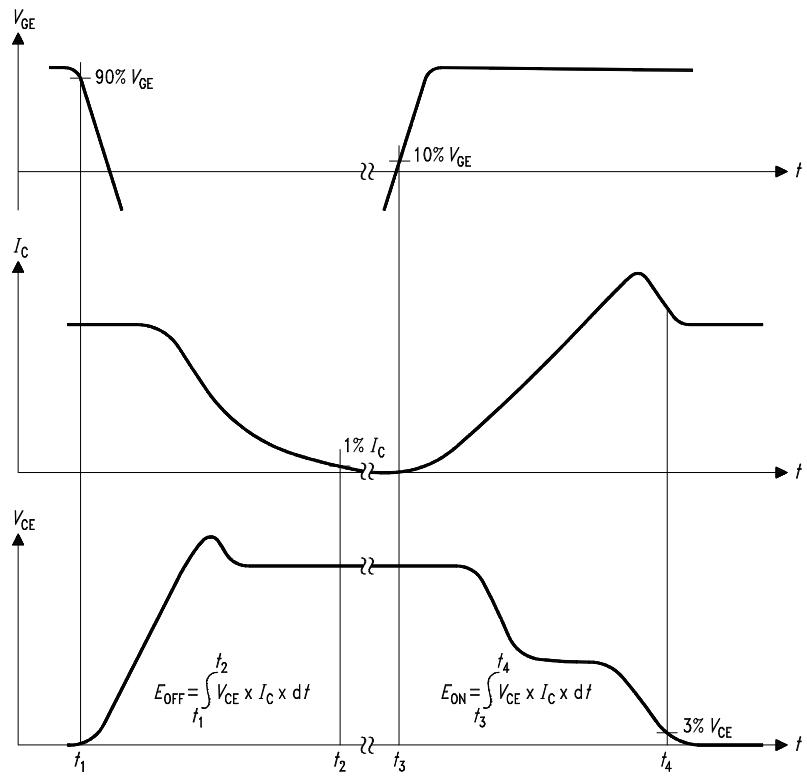
**Figure A. Definition of switching times**



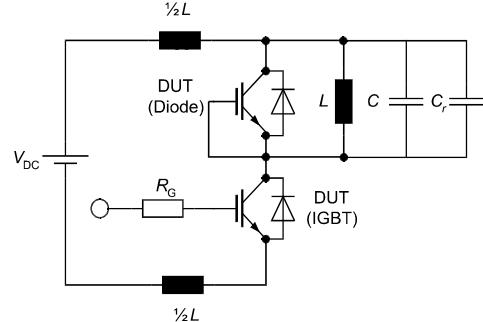
**Figure C. Definition of diodes switching characteristics**



**Figure D. Thermal equivalent circuit**



**Figure B. Definition of switching losses**



**Figure E. Dynamic test circuit**  
 Leakage inductance  $L = 180\text{nH}$ ,  
 Stray capacitor  $C_o = 40\text{pF}$ ,  
 Relief capacitor  $C_r = 1\text{nF}$   
 (only for ZVT switching)

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